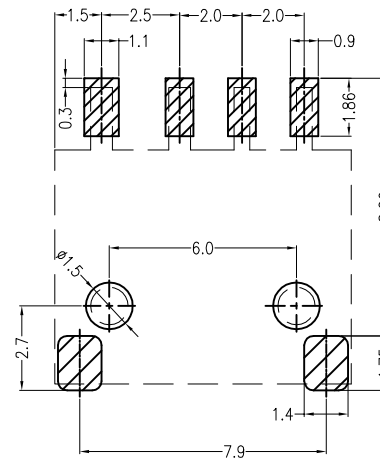
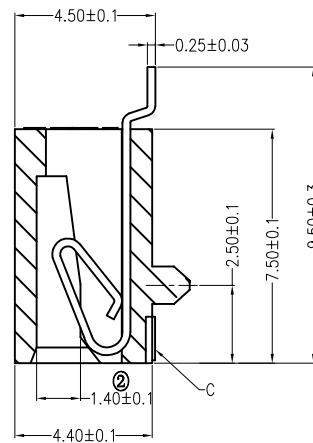
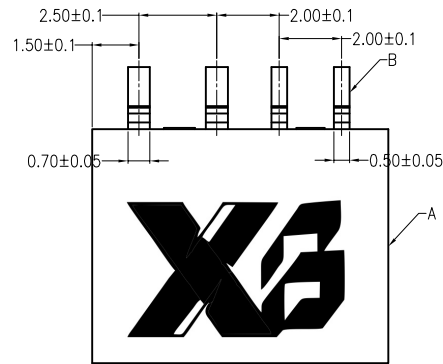
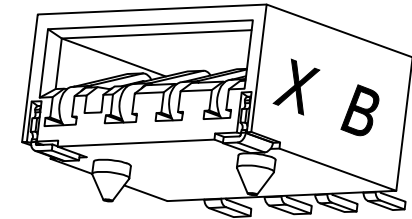


REV	DESCRIPTION	DESIGN	DATE
A0	Release	吴丹平	2016.04.30



Board Layout

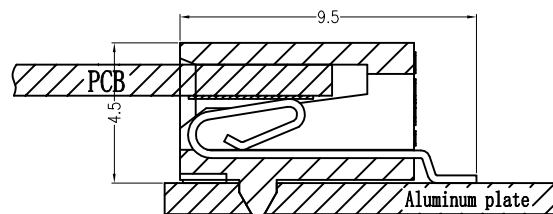
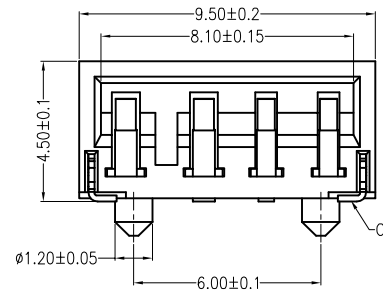


主要技术参数 Main Specifications

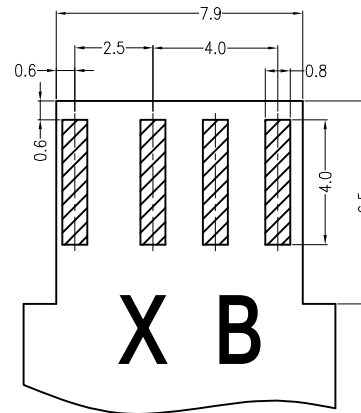
板 厚 (thickness): 1.0mm
接触电阻 (Contact resistance): $\leq 20m\Omega$
绝缘电阻 (Insulation resistance): $\geq 800M\Omega$
额定电压 (Rated voltage): 250/150V AC DC
额定电流 (Rated current): 1.0A AC DC
耐 电 压 (Withstand Voltage): 1500V AC/minute
温度范围 (Temperature Range): $-25^{\circ}C \sim +105^{\circ}C$

ORDER INFORMATION:

XB-L022-04-F2MB-R	
PART No.	PACKAGING:
No. OF CIRCUITS:	R=REEL
04	P=PE
PLASTIC MATERIAL:	PLATING:
F2M=LCP (BEIGE)	B=MATTE Sn



Assembly Layout



Mating Aluminum plate detail

C	Solder Tab	2 PCS	PhosphorBronze	MATTE Sn-plated
B	CONTACT	4 PCS	PhosphorBronze	MATTE Sn-plated
A	PEDESTAL	1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
东莞市溪榜电子有限公司 Switch Connector DONG GUAN XI BANG ELECTRONICS CO., LTD				
X.±0.5	X.±5°	USE:		PART NO.:
.X±0.3	.X±2°	CUSTOMER		L022-04-F2MB-R
.XX±0.25	.XX±1°	APPD: 邵敬和		DWG NO.:
--	--	CHKD: 田峰		GCCP-0080
⊕	⊖	DR: 周秀龙		SCALE
UNITS: mm		1 : 1		SHEET
				1 / 1